

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	1	"20040198063"	US-PGPUB	OR	OFF	2004/12/29 17:59
S1	0	310/309.ccls. and 438/712.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/27 07:51
S2	853	310/309.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:15
S3	182	S2 and spring and electric\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:20
S4	10	S3 and torsional near spring	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:17
S5	10	S4 and method	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:17
S6	7	S4 and method.clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:18
S7	81	S3 and mems	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:20
S8	5	S7 and (manufactur\$6 or process). clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/09/08 14:21
S9	6	("5,198,390" "5,536,988" "5,628, 917" "5,770,465" "6,000,280" "6, 073,484").pn.	USPAT	OR	OFF	2004/11/24 18:53
S10	5	310/309.ccls. and 438/50.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/24 19:19

S11	49	("6376445" "6287765" "5625647" "6352977" "5866483" "6117345" "6399805" "6342245" "6222244" "6222244" "6353009" "6440911" "4520396" "6284156" "4602963" "4769717" "5469509" "5930373" "6383509" "5309286" "6163200" "6399736" "6417267" "5770465" "6475753" "4962064" "6245662" "5231053" "5283208" "5289035" "5372675" "5403781" "5426059" "5858848" "6010955" "6033984" "6111292" "6147005" "6242346" "6245651" "6475905" "5723367" "5935766" "6159839" "4425183" "5670404" "5948705" "5445986" "5779926" "5869393").pn.	USPAT	OR	OFF	2004/12/03 17:55
S12	10	("4968585" "5256592" "5273939" "5296092" "5306659" "5316979" "5324683" "5372968" "5393375" "5407860").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2004/12/03 18:01
S13	12	("3672985" "4437226" "4670092" "4685198" "4740410" "4776924" "4783821" "4845048" "4853348" "4980317" "5072288").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2004/12/03 18:04
S14	34	("4437226").URPN.	USPAT	OR	OFF	2004/12/03 18:15
S15	50	(438/52 or 438/50 or 438/459 or 438/425 or 438/410 or 438/412 or 438/337 or 438/405 or 438/696 or 310/309 or 216/2 73/105 or 604/264 or 29/847 or 148/33.2). ccls. and silicon near6 remov\$4 near9 complet\$3 near9 oxid\$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/03 19:04
S16	35	(S11 or S12 or S13 or S14 or S15) and (oxidiz\$7.clm. and (silicon or wafer).clm.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/03 18:52
S17	10	("4437226" "4714520" "5426070" "5719073" "5846849" "5981402" "6020272" "6051866" "6239473" "6613675").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2004/12/03 18:35
S18	115	("4604162").URPN.	USPAT	OR	OFF	2004/12/03 18:52
S19	14	S18 and (oxidiz\$7.clm. and (silicon or wafer).clm.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/03 18:52

S20	13	(438/52 or 438/50 or 438/459 or 438/425 or 438/410 or 438/412 or 438/337 or 438/405 or 438/696 or 310/309 or 216/2 73/105 or 604/264 or 29/847 or 148/33.2). ccls. and silicon near6 remov\$4 near9 substantially near9 oxid\$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:16
S21	66	(438/52 or 438/50 or 438/459 or 438/425 or 438/410 or 438/412 or 438/337 or 438/405 or 438/696 or 310/309 or 216/2 73/105 or 604/264 or 29/847 or 148/33.2). ccls. and (substantially near9 oxid\$7 and (MEM\$2 or micro\$electro\$10))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:17
S22	13	(438/52 or 438/50 or 438/459 or 438/425 or 438/410 or 438/412 or 438/337 or 438/405 or 438/696 or 310/309 or 216/2 or 73/105 or 604/264 or 29/847 or 148/33.2). ccls. and silicon near6 remov\$4 near9 substantially near9 oxid\$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:25
S23	66	(438/52 or 438/50 or 438/459 or 438/425 or 438/410 or 438/412 or 438/337 or 438/405 or 438/696 or 310/309 or 216/2 or 73/105 or 604/264 or 29/847 or 148/33.2). ccls. and (substantially near9 oxid\$7 and (MEM\$2 or micro\$electro\$10))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:22
S24	535	438/712.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:22
S25	7	S24 and (substantially near9 oxid\$7 and (MEM\$2 or micro\$electro\$10))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:36
S26	2	S24 and silicon near6 remov\$4 near9 substantially near9 oxid\$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:52
S27	5	438/639.ccls. and (substantially near9 oxid\$7 and (MEM\$2 or micro\$electro\$10))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:34

S28	21929	438/337 438/410 438/52 438/410 438/234 438/53 438/52 438/696 338/307 438/52 438/425 216/2 310/309 216/2 438/412 216/2 73/105 73/105 438/405 438/412 438/412 148/33.2 604/264 438/714 29/847 438/50 438/459 438/426 438/50 438/712	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/07 12:35
S29	139	S28 and (substantially near9 oxid\$7 and (MEM\$2 or micro\$electro\$10))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:36
S30	37	S28 and silicon near6 remov\$4 near9 substantially near9 oxid\$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/07 12:52
S31	1936	216/2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/27 07:51
S32	465	S31 and mem	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/27 07:51
S33	131	S32 and oxidiz\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/27 07:51
S34	62	S32 and oxidiz\$6 near9 silicon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/27 09:46
S35	19	RIE near4 CHF3 near9 silicon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/27 10:23
S36	0	DRIE near9 CHF3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 13:57

S37	2	DRIE and CHF3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 14:08
S38	4	DRIE and CF4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 14:08
S39	479	RIE and CF4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 14:08
S40	190	RIE near9 CF4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 14:08
S41	91	RIE near9 CHF3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 14:08
S42	26	RIE near9 CHF3 near9 (silicon or Si)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 16:08
S43	145	bosch and fluorine and etching	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 16:08
S44	869664	bosch and fluorine and etching near9 silicon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 16:08
S45	120	bosch and fluorine and etching near9 silicon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 16:09
S46	2	S45 and CHF3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/12/29 16:09